



#### Results on Array-based Opto-Links

K.K. Gan, H.P. Kagan, R.D. Kass, H. Merritt, J. Moore, A. Nagarkar, D. Pignotti, S. Smith, M. Strang The Ohio State University

> P. Buchholz, A. Wiese, M. Ziolkowski Universität Siegen

> > July 8, 2011







#### • Introduction

- Results on 4-channel Driver/Receiver with Redundancy
- Design of New 12-channel Driver/Receiver with Redundancy
- Summary







- Optical data transmission is now preferred over copper wire links:
  - lower mass
  - much higher data transmission rate over long distance (80 m)
  - break the ground loop between front and back-end electronics
- Optical transmitter: vertical cavity surface-emitting laser (VCSEL)
- Optical receiver: PIN diode
- Optical device can have one, four, or twelve channels





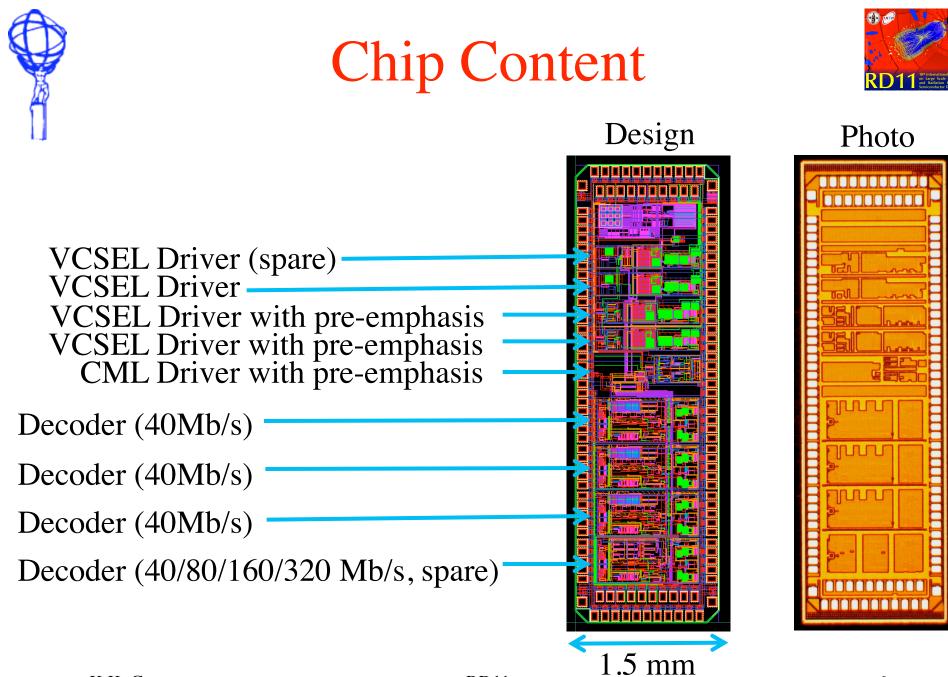
### Array Optical Links: Today

- array solution has three major advantages:
  - compact: more channels in less space
  - robust: 12-fiber ribbon is stronger than an individual fiber
  - efficient: can reserve 1 in 12 channels for redundancy instead doubling the number of channels
- 120 Gb/s VCSEL/PIN array based links are now commercial standard
  - 12-fiber ribbon, 12 channel VCSEL/PIN array, 10 Gb/s each
- 12-channel array VCSEL and PIN are available from several vendors
  - vendors forthcoming on providing reliability and qualification info
  - quite a different situation than in ~2003 when implementing array based on-detector links for ATLAS pixel detector
    - enabled fabrication of only 272 array-based opto-modules instead of 1,744 single-link opto-modules

K.K. Gan

# Driver/Receiver with Redundan

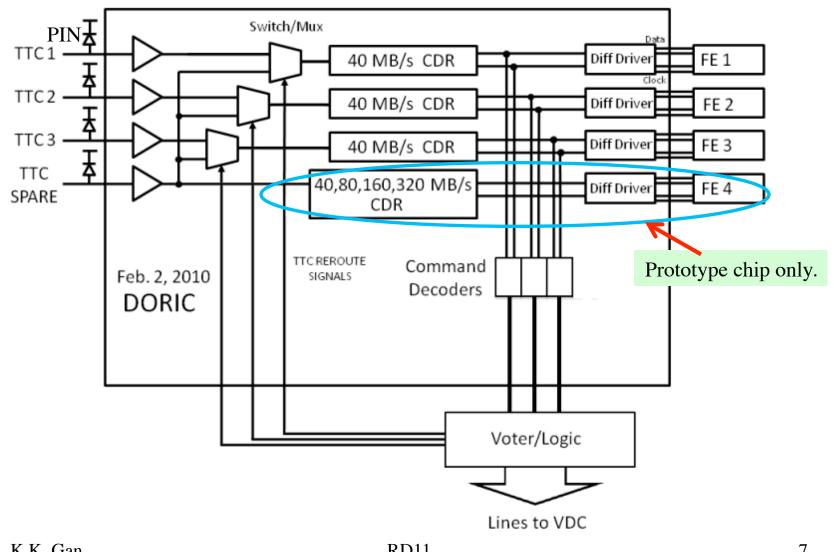
- designed an updated version of VCSEL driver and PIN receiver of current ATLAS Pixel detector but with redundancy
  - possible applications include current ATLAS pixel detector and its upgrade, IBL (Insertable Barrel Layer), in 2013-4
  - experience gained from the development/testing of such new chips would help the development of on-detector array-based opto-links for HL-LHC
  - submission of 1<sup>st</sup> prototype chip (130 nm CMOS) in 2/2010



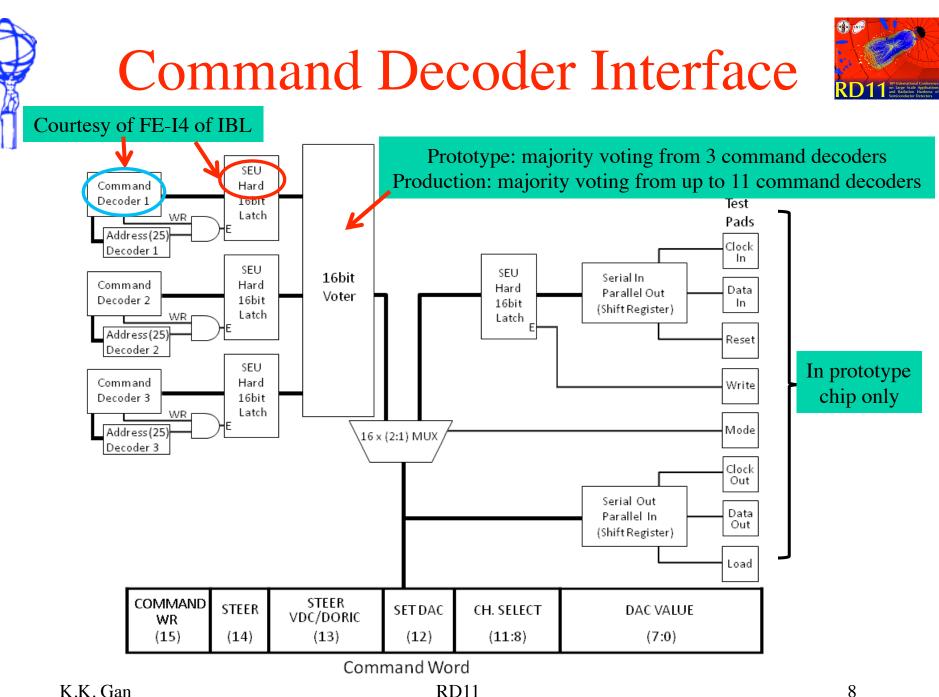




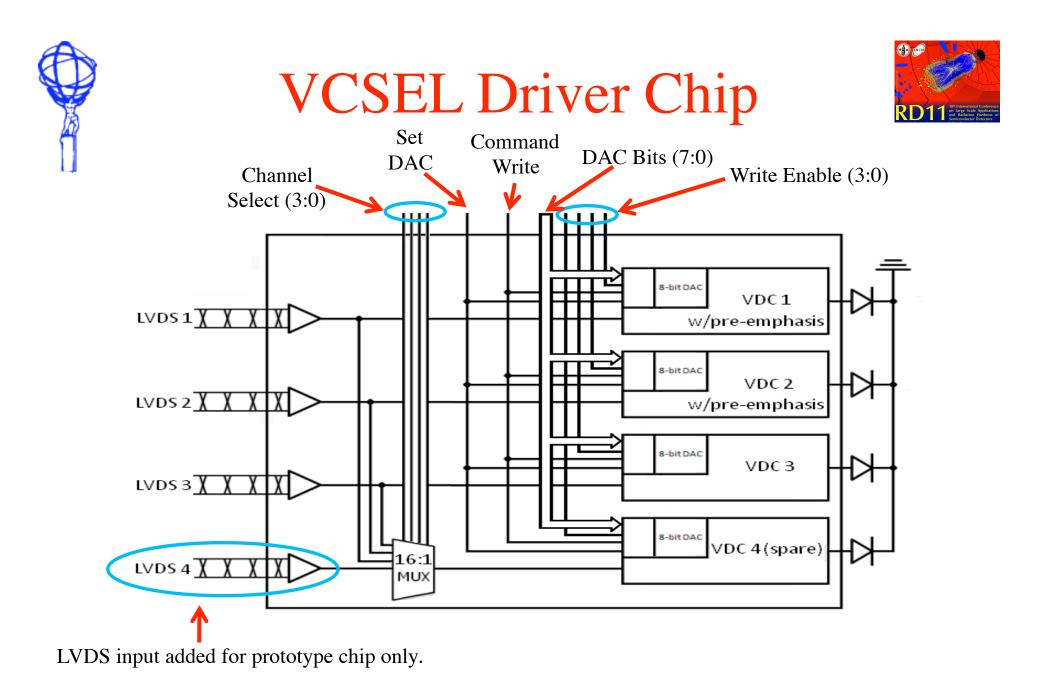
#### **PIN Receiver/Decoder**







K.K. Gan





### Irradiation



- 2 chips were packaged for irradiation with 24 GeV/c protons at CERN in August 2010
  - each chip contains 4 channels of drivers and receivers
  - total dose:  $1.6 \times 10^{15} \text{ protons/cm}^2$
  - all testing are electrical to avoid complications from degradation of optical components
     long cables limited testing to low speed
  - ✓ observe little degradation of devices





### Single Event Upset

- SEU harden latches or DAC could be upset by traversing particles
  - 40 latches per 4-channel chip
  - SEU tracked by monitoring the amplitude of VDC drive current
  - 13 instants (errors) of a channel steered
    to a wrong channel in 71 hours for chin t
    - to a wrong channel in 71 hours for chip #1
    - similar upset rate in chip #2
    - $\Rightarrow \sigma = 3x10^{-16} \text{ cm}^2$
    - particle flux  $\sim 3x10^9$  cm<sup>-2</sup>/year @ opto-link location
    - $\Rightarrow$  SEU rate ~10<sup>-6</sup>/year/link

### Summary of Prototype Chips



prototyped 4-channel VCSEL driver and PIN receiver/decoder:

- ✓ redundancy to bypass broken PIN or VCSEL channel
- ✓ individual VCSEL current control
- ✓ power-on reset to set VCSEL current to  $\sim 10$  mA on power up
- ✓ VCSEL driver can operate up to ~ 5 Gb/s with BER <  $5x10^{-13}$
- ✓ receiver/decoder properly decodes signal with low threshold
- irradiation with 24 GeV protons to 1.7 x 10<sup>15</sup> p/cm<sup>2</sup>
  - ✓ small decrease in VCSEL driver output current
  - ✓ very low SEU rate in latches:  $\sim 3x10^{-7}$ /year/link



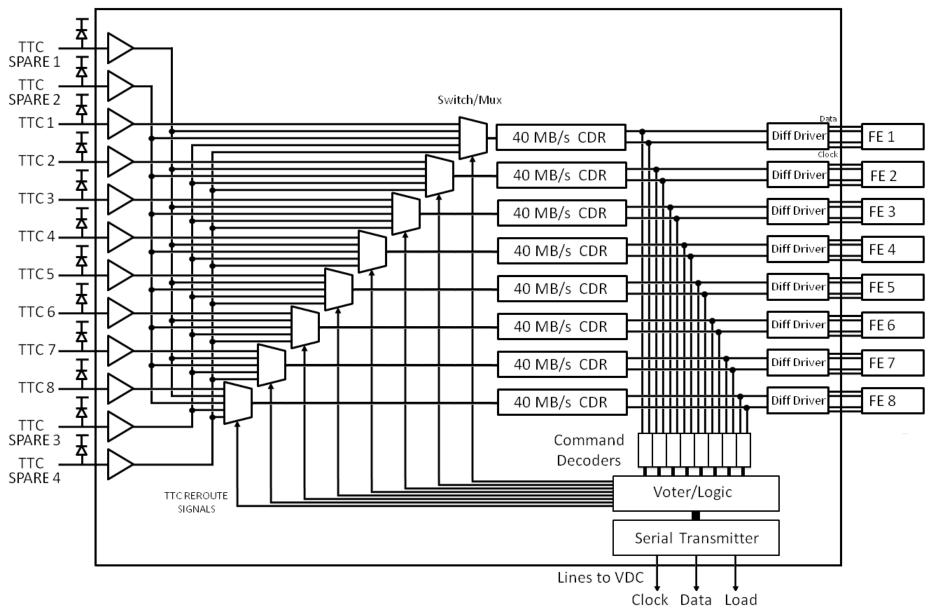
### 2011 PIN Receiver/Decoder

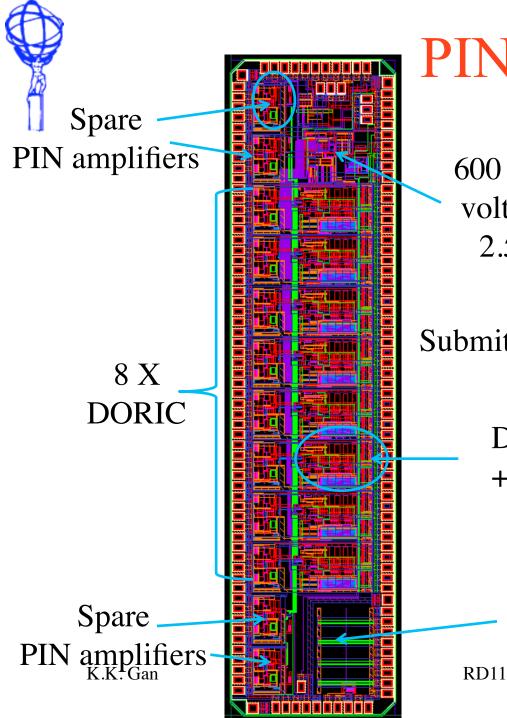
- Decodes 40 Mb/s bi-phase mark (BPM) signal
- 4 spare PIN receivers for redundancy
- 8 FE-I4 command decoders
  - Allows remote control by voting between commands received by the 8 FE-I4 command decoders
  - If one of the 8 inner PIN diodes fail
    - signal from one of the 4 redundant channel amplifier outputs can be steered to the digital portion of the failed channel
  - Majority voting of the command decoder values determines the command to be executed
  - Allows working control if only 2 PIN channels are alive





#### 2011 PIN Receiver/Decoder





## PIN Receiver/Dec

600 μm x 900 μm voltage regulator 2.5 V ⇔1.5 V

Submitted May 2011 – 6.5 mm x 1.6 mm

DLL + command decoder + LVDS driver

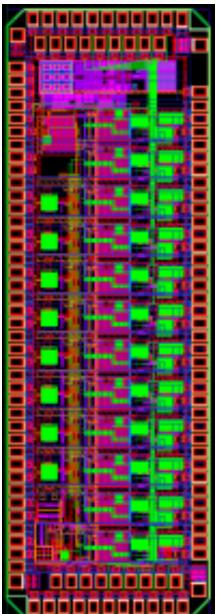
 $600 \ \mu m \ge 900 \ \mu m$  control logic



### **VCSEL** Driver Chip

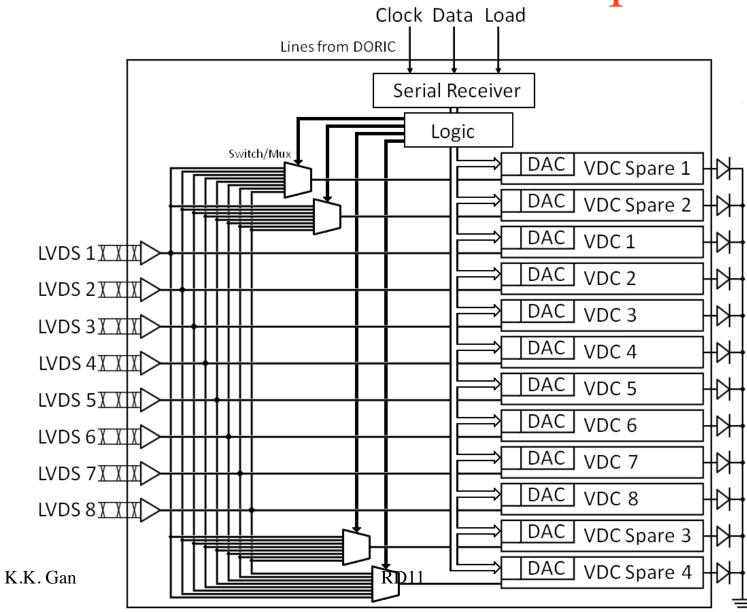


- Designed for 8 channel operation up to 5 Gb/s
- 4 spare VCSEL driver outputs
- Receives serial data from PIN receiver/decoder (command decoder vote) for configuration
- If one of the 8 inner VCSELs fail
  - the data signal from the detector can be steered to any of the spare VCSELs
- 8 bit DAC for remote control of individual VCSEL current
- Submitted May 2011 1.5 mm x 4.5 mm





### **VCSEL** Driver Chip



17





### Summary

- 4-channel driver/receiver chips with redundancy and other improvements work well
- 12-channel driver/receiver chips with redundancy submitted in May
  - irradiation in September 2011
- Submit 4-channel driver/receiver compatible with HL-LHC in 2012